



BML60N165UC1

Super Junction Power MOSFET

600 V, 21 A, 165 mΩ

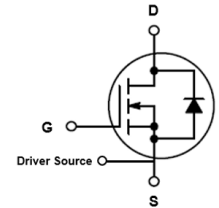
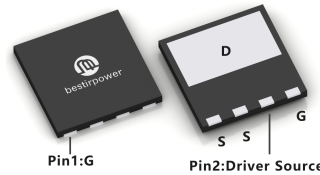
Description

BML60N165UC1 is power MOSFET using bestirpower's advanced super junction technology that can realize very low on resistance and gate charge. It will provide much high efficiency by using optimized charge coupling technology. These user friendly devices give an advantage of Low EMI to designers as well as low switching loss.

Features

$BV_{DSS} @ T_{J,max}$	I_D	$R_{DS(on),max}$	$Q_{g,typ}$
650 V	21 A	165 mΩ	40 nC

- Ultra-fast body diode.
- Extremely low losses due to very low FOM $R_{dson} \cdot Q_g$ and E_{oss} .
- Very high commutation ruggedness.



Applications

- AC/DC power supply.
- PC power.
- Telecom/Sever.
- Solar inverter.



Absolute Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DSS}	Drain to Source Voltage ¹⁾	600	V
V_{GSS}	Gate to Source Voltage ²⁾	± 30	V
I_D	Drain Current	$V_{GS} = 10\text{ V}, (T_C = 25^\circ\text{C})$	21
		$V_{GS} = 10\text{ V}, (T_C = 100^\circ\text{C})$	13.5
I_{DM}	Drain Current	Pulsed ($T_C = 25^\circ\text{C}$)	60
E_{AS}	Single Pulsed Avalanche Energy ³⁾	320	mJ
I_{AR}	Repetitive Avalanche Energy	3.6	A
dv/dt	MOSFET dv/dt	50	V/ns
	Peak Diode Recovery dv/dt ⁴⁾	50	
P_{tot}	Power Dissipation	($T_C = 25^\circ\text{C}$)	152
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_{sold}	Soldering temperature, wavesoldering only allowed at leads	260	$^\circ\text{C}$

1) Limited by T_j max. Maximum duty cycle $D=0.75$.

2) Pulse width t_p limited by T_j, max .

3) $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_j=25^\circ\text{C}$.

4) $V_{DCLink}=400\text{V}$; $V_{DS,peak} < V(BR)DSS$; identical low side and high side switch with identical R_G .

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.82	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62	

Electrical Characteristics (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 1 mA	600	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V, T _J = 25°C	-	-	10	μA
I _{GSS}	Gate-Source Leakage Current	V _{GS} = ±30 V, V _{DS} = 0 V	-	-	±100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	3.0	4.0	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 7 A, T _J = 25°C	-	150	165	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0V, f = 250 kHz	-	1670	-	pF
C _{oss}	Output Capacitance		-	68	-	pF
C _{rss}	Reverse transfer capacitance		-	4.3	-	pF
C _{o(er)}	Energy Related Output Capacitance ¹⁾	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	-	53	-	pF
C _{o(tr)}	Time Related Output Capacitance ²⁾		-	268	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	V _{DD} = 400 V, I _D = 7 A, V _{GS} = 0 to 10 V	-	40	-	nC
Q _{gs}	Gate to Source Charge		-	9	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	17	-	nC
R _G	Gate Resistance		F = 1 MHz, open drain	-	4	-
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 400 V, I _D = 7 A, V _{GS} = 10 V	-	11	-	ns
t _r	Turn-On Rise Time		-	13	-	ns
t _{d(off)}	Turn-Off Delay Time		-	59	-	ns
t _f	Turn-Off Fall Time		-	5	-	ns
Source-Drain Diode Characteristics						
I _S	Maximum Continuous Diode Forward Current		-	-	21	A
I _{SM}	Maximum Pulsed Diode Forward Current		-	-	60	A
V _{SD}	Diode Forward Voltage	V _{GS} = 0 V, I _F = 7 A, T _J = 25°C	-	0.88	-	V
t _{rr}	Reverse Recovery Time	V _R = 400 V, I _F = 7 A, di _F /dt = 100 A/μs	-	145	-	ns
Q _{rr}	Reverse Recovery Charge		-	1	-	μC
I _{rrm}	Peak reverse recovery current		-	10	-	A

1) C_{o(er)} is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V.

2) C_{o(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V.

Typical Performance Characteristics

Figure 1. Power dissipation

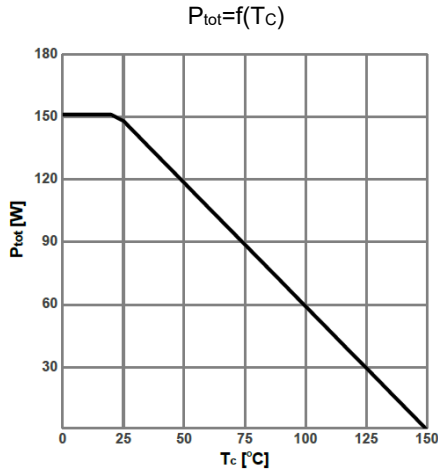


Figure 2. Max. transient thermal impedance

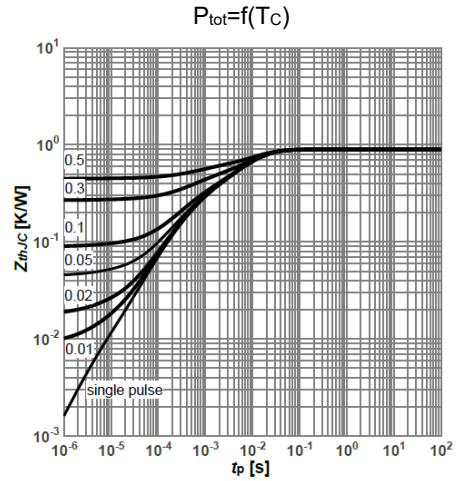


Figure 3. Safe operating area

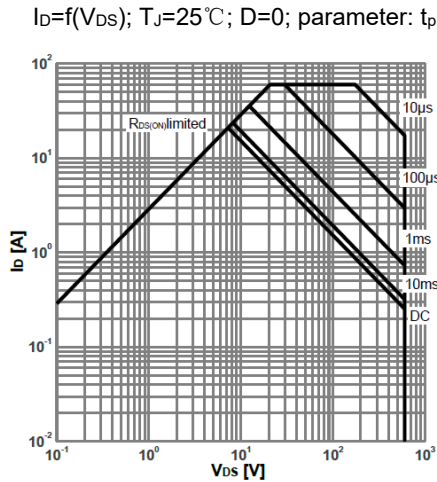


Figure 4. Typ. output characteristics

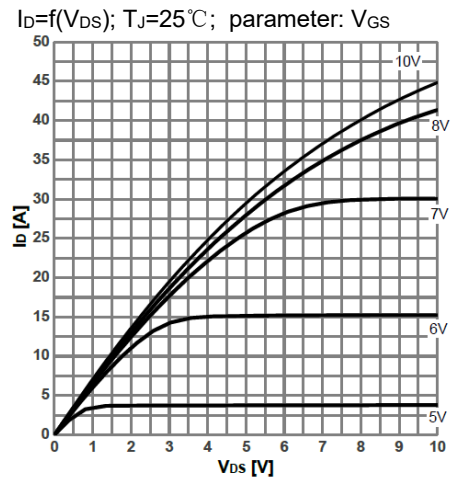


Figure 5. Typ. output Characteristics

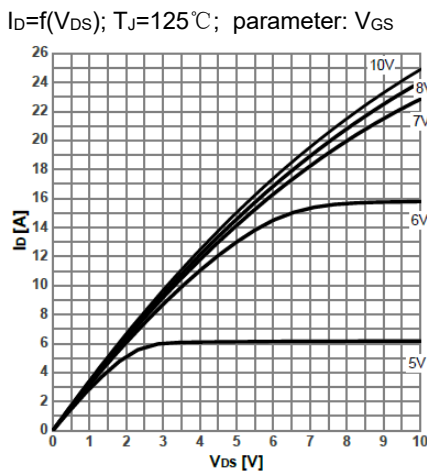
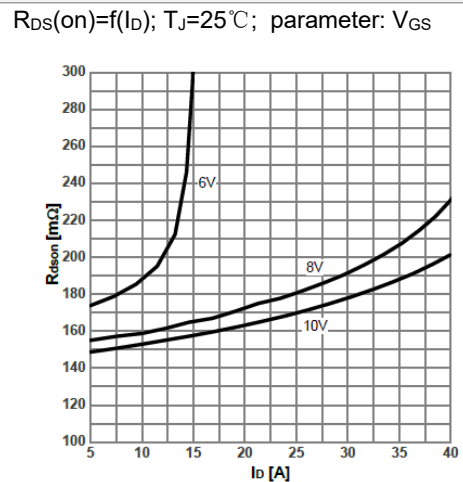


Figure 6. Typ. drain-source on-state resistance



Typical Performance Characteristics

Figure 7. Drain-source on-state resistance

$R_{ds(on)}=f(T_j)$; $I_D=7A$, $V_{GS}=10V$

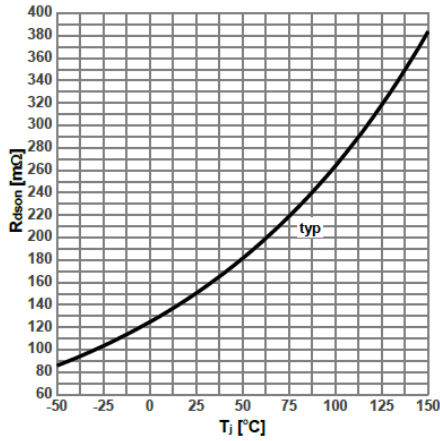


Figure 8. Typ. transfer characteristics

$I_D=f(V_{GS})$; $V_{DS}=20V$; parameter: T_J

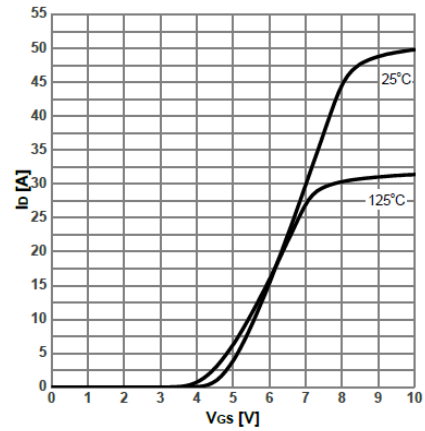


Figure 9. Typ. gate charge

$V_{GS}=f(Q_{gate})$; $I_D=7A$ pulsed; $V_{DS}=400V$

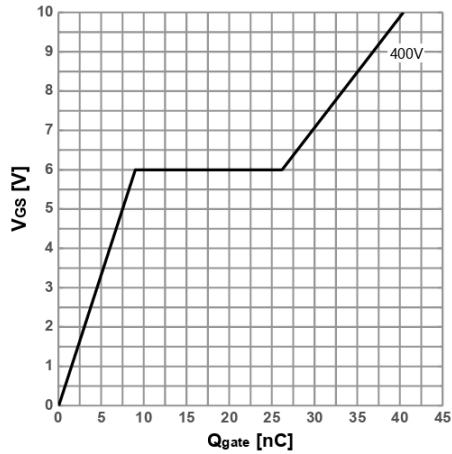


Figure 10. Forward characteristics of reverse diode

$I_F=f(V_{SD})$; parameter: T_J

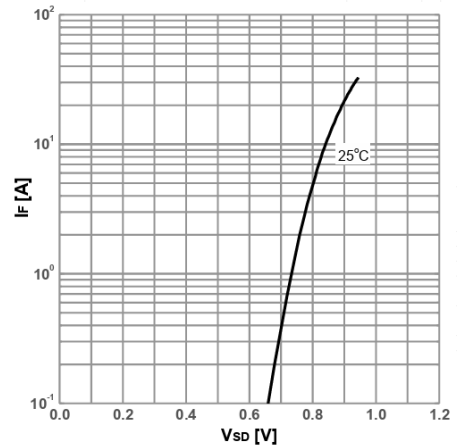


Figure 11. Drain-source breakdown voltage

$V_{BR(DSS)}=f(T_j)$; $I_D=1mA$

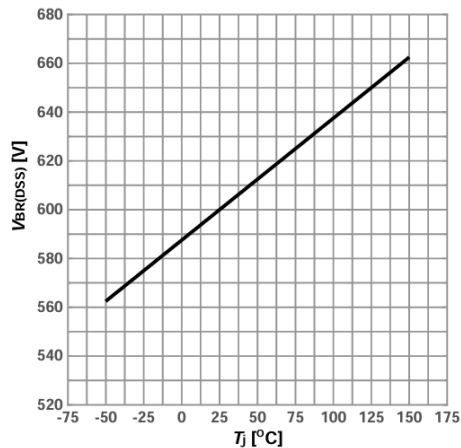


Figure 12. Typ. capacitances

$C=f(V_{DS})$; $V_{GS}=0V$; $f=250KHz$

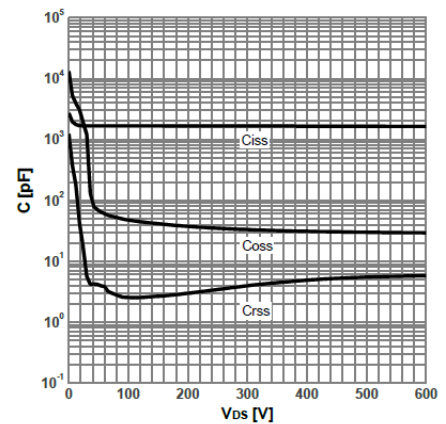
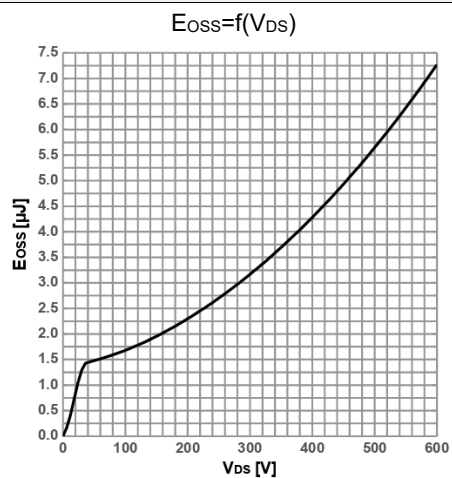


Figure 13. Typ. Coss stored energy



Test Circuits

Figure 14. Diode Characteristics

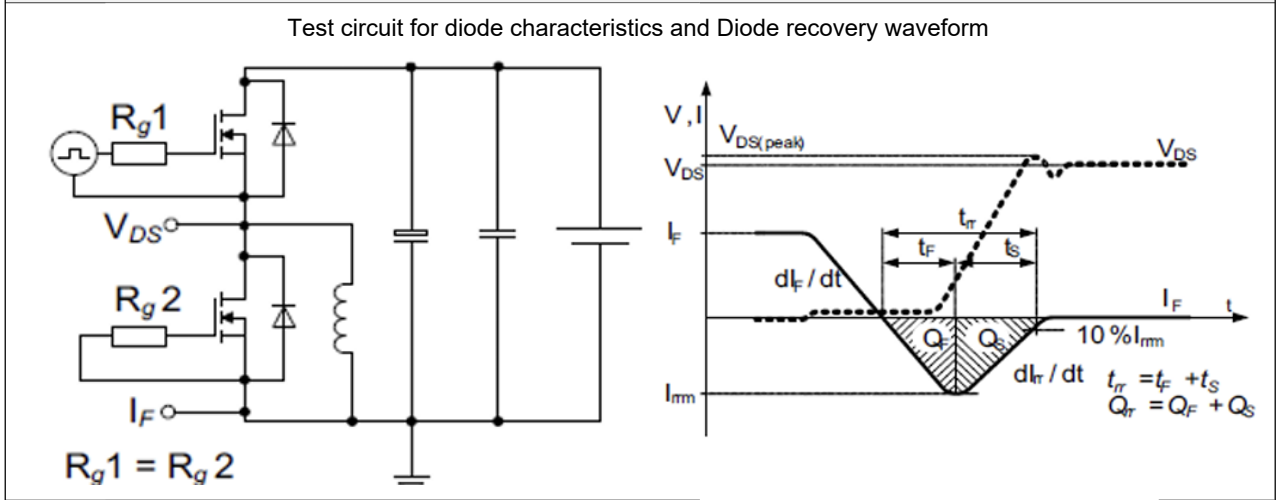


Figure 15. Switching Times

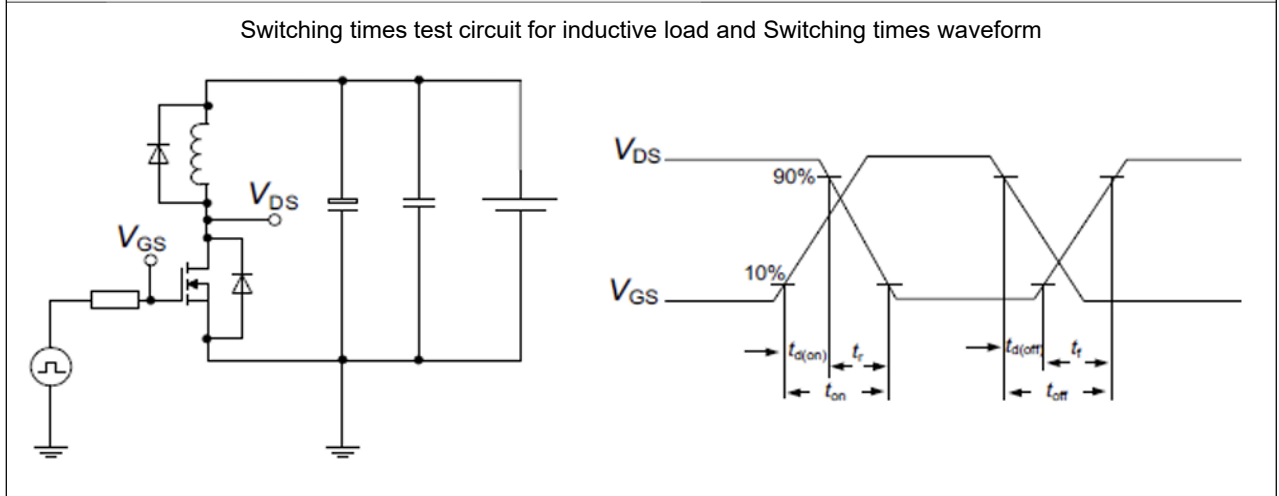
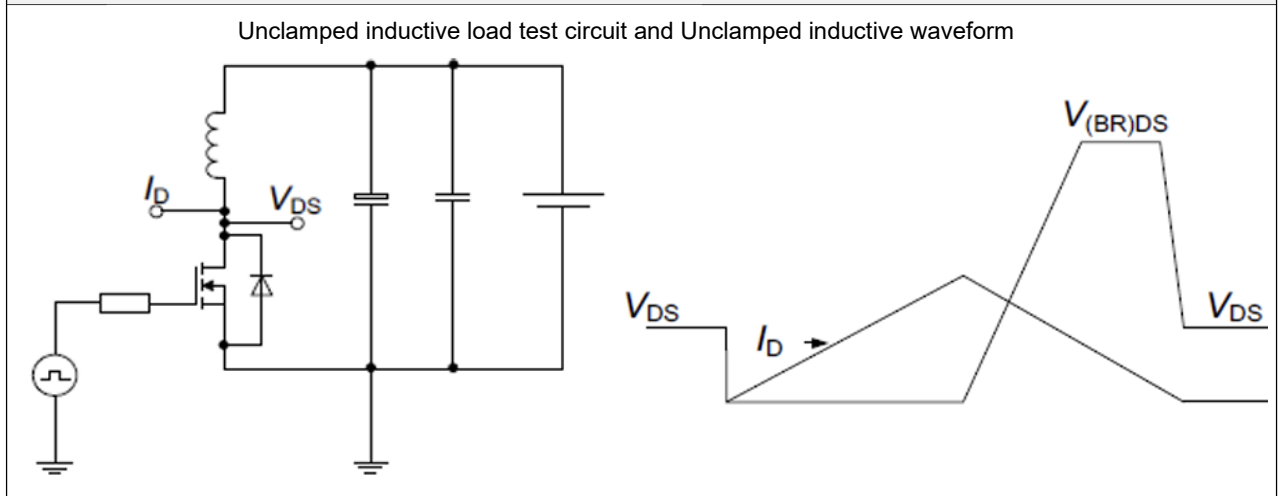
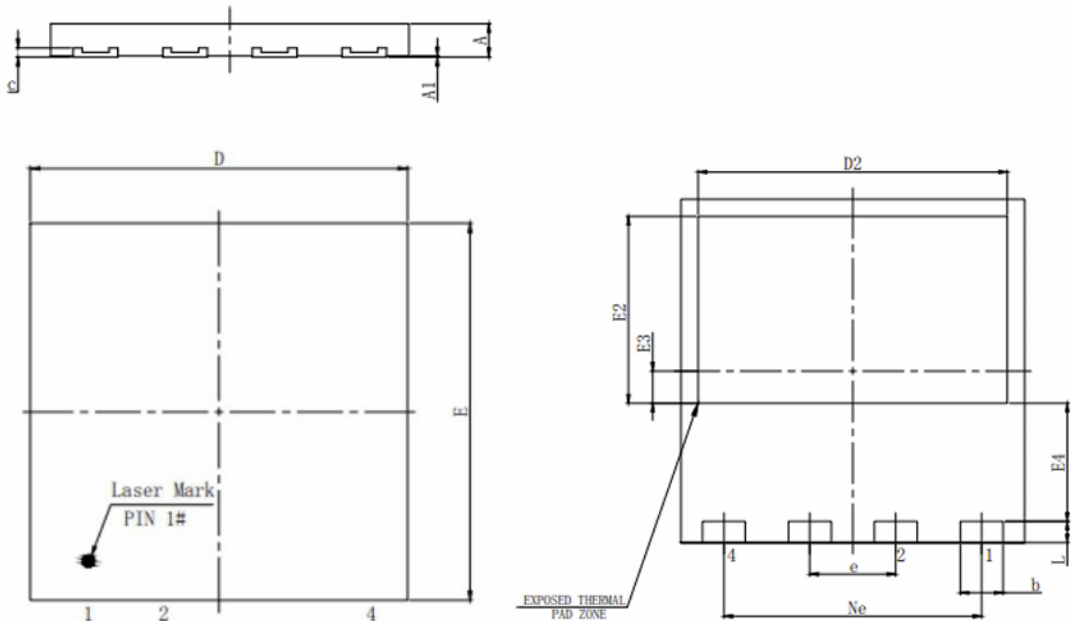


Figure 16. Unclamped Inductive Load



Package Outlines

DFN 8*8



Symbol	Dimensions In Millimeters		
	Min	Nom	Max
D	7.90	8.00	8.10
E	7.90	8.00	8.10
D2	7.10	7.20	7.30
E2	4.25	4.35	4.45
e	2.00BSC		
E3	0.75REF		
E4	2.75REF		
Ne	6.00BSC		
b	0.95	1.00	1.05
A	0.70	0.75	0.80
c	0.203REF		
A1	0	/	0.050
L	0.40	0.50	0.55

BML60N165UC1

600V 165mΩ Power MOSFET



Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
BML60N165UC1	BML60N165UC1	DFN8*8	Tape & Reel	5000units

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